



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Manufacturing Info/ Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Penica, John R	Contact Title	Mgr Environmental Engineering		
Company Unique ID	TE Connectivity	Response Date	2014-11-13	Contact Email	jrpenica@te.com				
Contact Phone Number		+1-717-592-3266							
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	1-1337445-0	Amount	4452.8	Version	-	Identity			
Manufacturer Item Name		Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) meets EU RoHS requirements by application of the selected exemption(s) - true								
ChinaRoHS-0508	Product(s) requires marking for the presence of restricted substances and must be marked with an Environmental Protection Use Period under China's Measures for Administration of the control of pollution by Electronic Information Products - true								
EUREACH-1213	Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH - true								
Manufacturing Information									
J-STD-020 MSL Rating		Max Total a Wave Time		Ramp Rate		Wave Additional Info			
Classification Temp		Max Wave Solder Time	0.0	Ramp Down Rate		Psi Rating Reflow			
Max Time Within 5		Psi Rating Wave		Package Designator		Size	0.0		
Time Above 217		Reflow Additional Info		Preheat Max Temp		Terminal Base Alloy	NAC		
Preheat Duration		bulk Solder Termination	NAC	Nbr or Reflow Cycles		Terminal Plating	NAC		
Preheat Min Temp		Nbr of Instances	0	Component Temp Spike		Shape	NAC		
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Material	1	COPPER ALLOY_BODY				1.0	3560.0	mg	
Substance	2	Iron	Supplier	7439-89-6	0.32	1.0	11.392	mg	
Substance	2	Zinc	Supplier	7440-66-6	37.87995	1.0	1348.52622	mg	
Substance	2	Tin	Supplier	7440-31-5	0.4	1.0	14.24	mg	
Substance	2	Copper	Supplier	7440-50-8	58.08	1.0	2067.648	mg	
Substance	2	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	5.0E-5	1.0	0.00178	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	3.32	1.0	118.192	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Material	1	INSULATION-PTFE INSULATION				1.0	370.0	mg	
Substance	2	Ethene, 1,1,2,2-tetrafluoro-, homopolymer	Supplier	9002-84-0	100.0	1.0	370.0	mg	
Material	1	COPPER ALLOY_CONT ACT				1.0	250.0	mg	
Substance	2	Tin	Supplier	7440-31-5	0.4	1.0	1.0	mg	
Substance	2	Copper	Supplier	7440-50-8	58.08	1.0	145.2	mg	
Substance	2	Iron	Supplier	7439-89-6	0.32	1.0	0.8	mg	
Substance	2	Zinc	Supplier	7440-66-6	37.87995	1.0	94.69988	mg	

Substance	2	Lead	Lead/Lead Compounds	7439-92-1	3.32	1.0	8.3	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Substance	2	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	5.0E-5	1.0	1.25E-4	mg	
Material	1	BODY-SILVER PLATING BODY				1.0	80.0	mg	
Substance	2	Silver	Supplier	7440-22-4	100.0	1.0	80.0	mg	
Material	1	CONTACT-SILVER PLATING CONTACT				1.0	8.0	mg	
Substance	2	Silver	Supplier	7440-22-4	100.0	1.0	8.0	mg	
Material	1	COPPER ALLOY SLEEVE-Brass(SPEC.JIS C2680)				1.0	178.0	mg	
Substance	2	Zinc	Supplier	7440-66-6	32.377	1.0	57.63106	mg	
Substance	2	Iron	Supplier	7439-89-6	0.02	1.0	0.0356	mg	
Substance	2	Copper	Supplier	7440-50-8	67.6	1.0	120.328	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.0030	1.0	0.00534	mg	
Material	1	SLEEVE-SILVER PLATING_SLEEVE				1.0	6.8	mg	
Substance	2	Silver	Supplier	7440-22-4	100.0	1.0	6.8	mg	